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October 30, 2002

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Name of Conveying Party(ies): (1) Toshihiro TAI and (2) Ippei TONOSAKI

Name and Address of Receiving Party(ies):
DAICEL POLYMER LTD.
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JAPAN

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Execution Date of Document: (1 & 2) September 30, 2002

If this document is being filed together with a new application, the execution date of the application is:

Patent Application Numbers: 10/238 909

Patent Numbers:

Total Number of Applications and Patents Involved: one (1). An enclosed check includes the recording fee of \$40.00. The Commissioner is hereby authorized to credit any overpayment, or to charge any additional recording fee required by this paper, to Deposit Account No. 06-1382.

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To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy is a true copy of the original document.

Respectfully submitted,

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08/2002 DBYRNE 00000045 10238909

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120.9803

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PATENT REEL: 013460 FRAME: 0864 WHEREAS, I/We, (1) Toshihiro TAI and (2) Ippei TONOSAKI

residing at (1) 1-1-2-520, Tokiwacho, Sakai-shi, Osaka, JAPAN; and (2) 1090-503, Sawa, Kaizuka-shi, Osaka, JAPAN

have invented certain new and useful improvements in PLATING RESIN MOLDED ARTICLE AND PROCESS FOR PRODUCING THE SAME for which an application for United States Letters patent was filed on September 10, 2002 as U. S. Application Serial No. 10/238 909

WHEREAS, DAICEL POLYMER LTD.

RECORDED: 11/04/2002

having a place of business at 3-2-5, Kasumigaseki, Chiyoda-ku, Tokyo, JAPAN

hereinafter called the "Assignee", is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefor, in the United States and its territorial possessions.

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other valuable considerations, the receipt whereof is hereby acknowledged, I/we have sold, assigned and transferred, and by these presents do sell, assign, transfer and confirm in and to said Assignee my/our full and exclusive right to the said invention in the United States and its territorial possessions and my/our entire right, title and interest in and to said application and any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in and to any and all divisions, reissues, continuations and extensions thereof.

I/We hereby authorize and request the Patent Office Officials in the United States to issue any and all of said Letters Patent, when granted, to said Assignee for the sole use and behoof of the said Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, I/we have hereunto set my/our hand(s).

Witnessed by:	<pre>Inventor(s):</pre>	Date:
	Jou Toshihiro TAI	Sep. 30, 2002
	I TONO SAKI	Sep. 30, 2002

PATENT REEL: 013460 FRAME: 0865